

Description

This document details the custom configuration that is programmed into the one-time-programmable (OTP) memory of the 9FGV1006C002LTGI. Please refer to the device datasheet for further information about the device.

General Configuration

Parameter	Value	Units
Device I ² C Address	Primary 0xD0	_
Default Configuration at I ² C Mode	0	_

Frequency Overview

Parameter	Configuration 0	Configuration 1	Configuration 2	Configuration 3	Units
Input	25	25	25	25	MHz
REF 0	_	_	_	_	_
Output 0	100	100	100	100	MHz
Output 1	100	100	100	100	MHz

Configuration 0 Parameters: SEL[1:0] = 00

Input frequency: 25MHz; crystal load capacitance: 8.19pF

Parameter	REF 0	Output 0	Output 1	Units
Frequency	25	100	100	MHz
Default Output Status	Off	On	On	_
VDDO Voltage	Low	1.8	1.8	V
Output Type	LVCMOS	LP-HCSL	LP-HCSL	_
Spread Spectrum	_	_	_	%
Spread Spectrum Modulation	_	_	_	kHz
LP-HCSL Impedance	_	100	100	Ω



Configuration 1 Parameters: SEL[1:0] = 01

Input frequency: 25MHz; crystal load capacitance: 8.19pF

Parameter	REF 0	Output 0	Output 1	Units
Frequency	25	100	100	MHz
Default Output Status	Off	On	On	_
VDDO Voltage	Low	1.8	1.8	V
Output Type	LVCMOS	LP-HCSL	LP-HCSL	_
Spread Spectrum	_	-0.1	-0.1	%
Spread Spectrum Modulation	_	31.5	31.5	kHz
LP-HCSL Impedance	_	100	100	Ω

Configuration 2 Parameters: SEL[1:0] = 10

Input frequency: 25MHz; crystal load capacitance: 8.19pF

Parameter	REF 0	Output 0	Output 1	Units
Frequency	25	100	100	MHz
Default Output Status	Off	On	On	_
VDDO Voltage	Low	1.8	1.8	V
Output Type	LVCMOS	LP-HCSL	LP-HCSL	_
Spread Spectrum	_	-0.3	-0.3	%
Spread Spectrum Modulation	_	31.5	31.5	kHz
LP-HCSL Impedance	_	100	100	Ω

Configuration 3 Parameters: SEL[1:0] = 11

Input frequency: 25MHz; crystal load capacitance: 8.19pF

Parameter	REF 0	Output 0	Output 1	Units
Frequency	25	100	100	MHz
Default Output Status	Off	On	On	_
VDDO Voltage	Low	1.8	1.8	V
Output Type	LVCMOS	LP-HCSL	LP-HCSL	_
Spread Spectrum	_	-0.5	-0.5	%
Spread Spectrum Modulation	_	31.5	31.5	kHz
LP-HCSL Impedance	_	100	100	Ω



Package Outline Drawings and Marking Diagrams

Refer to the datasheet for detailed information pertaining to package outline drawings and marking diagrams.

Ordering Information

Orderable Part Number	Carrier Type	Temperature	Crystal
9FGV1006C002LTGI	Tray	-40° to +85°C	External
9FGV1006C002LTGI8	Tape and Reel	-40° to +85°C	External

Revision History

Revision Date	Description of Change
September 17, 2020	Initial release.

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